

## Resonant Switching Series

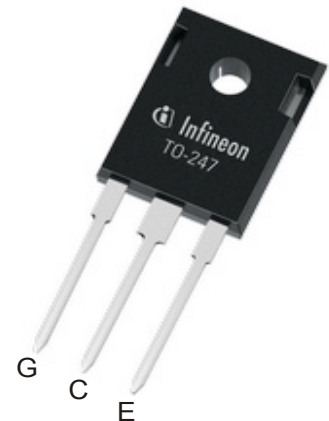
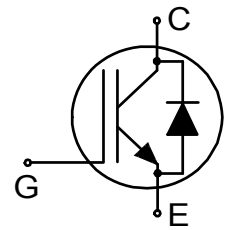
## Reverse conducting IGBT with monolithic body diode

**Features:**

- Powerful monolithic body diode with low forward voltage designed for soft commutation only
- TRENCHSTOP™ technology applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - low  $V_{CEsat}$
  - easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low EMI
- Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>

**Applications:**

- Inductive cooking
- Inverterized microwave ovens
- Resonant converters
- Soft switching applications

**Key Performance and Package Parameters**

| Type        | $V_{CE}$ | $I_C$ | $V_{CEsat}, T_{vj}=25^{\circ}C$ | $T_{vjmax}$ | Marking  | Package    |
|-------------|----------|-------|---------------------------------|-------------|----------|------------|
| IHW15N120R3 | 1200V    | 15A   | 1.48V                           | 175°C       | H15R1203 | PG-TO247-3 |

### Table of Contents

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## Resonant Switching Series

## Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

| Parameter  | Symbol      | Value                | Unit             |
|--|-------------|----------------------|------------------|
| Collector-emitter voltage  | $V_{CE}$    | 1200                 | V                |
| DC collector current, limited by $T_{vjmax}$<br>$T_c = 25^\circ\text{C}$<br>$T_c = 100^\circ\text{C}$  | $I_C$       | 30.0<br>15.0         | A                |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$   | $I_{Cpuls}$ | 45.0                 | A                |
| Turn off safe operating area $V_{CE} \leq 1200\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$              | -           | 45.0                 | A                |
| Diode forward current, limited by $T_{vjmax}$<br>$T_c = 25^\circ\text{C}$<br>$T_c = 100^\circ\text{C}$ | $I_F$       | 30.0<br>15.0         | A                |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$   | $I_{Fpuls}$ | 45.0                 | A                |
| Gate-emitter voltage<br>Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )      | $V_{GE}$    | $\pm 20$<br>$\pm 25$ | V                |
| Power dissipation $T_c = 25^\circ\text{C}$<br>Power dissipation $T_c = 100^\circ\text{C}$              | $P_{tot}$   | 254.0<br>127.0       | W                |
| Operating junction temperature   | $T_{vj}$    | -40...+175           | $^\circ\text{C}$ |
| Storage temperature  | $T_{stg}$   | -55...+175           | $^\circ\text{C}$ |
| Soldering temperature,<br>wave soldering 1.6mm (0.063in.) from case for 10s                            |             | 260                  | $^\circ\text{C}$ |
| Mounting torque, M3 screw<br>Maximum of mounting processes: 3  | $M$         | 0.6                  | Nm               |

## Thermal Resistance

| Parameter                                    | Symbol        | Conditions | Value |      |      | Unit |
|--|---------------|------------|-------|------|------|------|
|  |               |            | min.  | typ. | max. |      |
| <b><math>R_{th}</math> Characteristics</b>   |               |            |       |      |      |      |
| IGBT thermal resistance,<br>junction - case  | $R_{th(j-c)}$ |            | -     | -    | 0.59 | K/W  |
| Diode thermal resistance,<br>junction - case | $R_{th(j-c)}$ |            | -     | -    | 0.59 | K/W  |
| Thermal resistance<br>junction - ambient     | $R_{th(j-a)}$ |            | -     | -    | 40   | K/W  |

## Resonant Switching Series

Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified

| Parameter                            | Symbol        | Conditions                                  | Value |      |      | Unit          |
|--------------------------------------|---------------|---|-------|------|------|---------------|
|                                      |               |   | min.  | typ. | max. |               |
| <b>Static Characteristic</b>         |               |   |       |      |      |               |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE} = 0\text{V}, I_C = 0.50\text{mA}$   | 1200  | -    | -    | V             |
| Collector-emitter saturation voltage | $V_{CESat}$   | $V_{GE} = 15.0\text{V}, I_C = 15.0\text{A}$ | -     | 1.48 | 1.70 | V             |
|                                      |               | $T_{vj} = 25^{\circ}\text{C}$               | -     | 1.70 | -    |               |
|                                      |               | $T_{vj} = 125^{\circ}\text{C}$              | -     | 1.80 | -    |               |
| Diode forward voltage                | $V_F$         | $V_{GE} = 0\text{V}, I_F = 15.0\text{A}$    | -     | 1.55 | 1.75 | V             |
|                                      |               | $T_{vj} = 25^{\circ}\text{C}$               | -     | 1.70 | -    |               |
|                                      |               | $T_{vj} = 125^{\circ}\text{C}$              | -     | 1.80 | -    |               |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C = 0.40\text{mA}, V_{CE} = V_{GE}$      | 5.1   | 5.8  | 6.4  | V             |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}$ | -     | -    | 100  | $\mu\text{A}$ |
|                                      |               | $T_{vj} = 25^{\circ}\text{C}$               | -     | -    | 2500 |               |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE} = 0\text{V}, V_{GE} = 20\text{V}$   | -     | -    | 100  | nA            |
|                                      |               | $T_{vj} = 175^{\circ}\text{C}$              | -     | -    | 100  |               |
| Transconductance                     | $g_{fs}$      | $V_{CE} = 20\text{V}, I_C = 15.0\text{A}$   | -     | 13.9 | -    | S             |
| Integrated gate resistor             | $r_G$         |   |       | none |      | $\Omega$      |

Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified

| Parameter  | Symbol    | Conditions  | Value |       |      | Unit          |
|--|-----------|---|-------|-------|------|---------------|
|  |           |   | min.  | typ.  | max. |               |
| <b>Dynamic Characteristic</b>                                  |           |   |       |       |      |               |
| Input capacitance  | $C_{ies}$ | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$      | -     | 1165  | -    | $\mu\text{F}$ |
| Output capacitance   | $C_{oes}$ |   | -     | 40    | -    |               |
| Reverse transfer capacitance                                   | $C_{res}$ |   | -     | 32    | -    |               |
| Gate charge  | $Q_G$     | $V_{CC} = 960\text{V}, I_C = 15.0\text{A}, V_{GE} = 15\text{V}$ | -     | 165.0 | -    | nC            |
| Internal emitter inductance measured 5mm (0.197 in.) from case | $L_E$     |   | -     | 13.0  | -    | nH            |

## Switching Characteristic, Inductive Load

| Parameter   | Symbol       | Conditions   | Value |      |      | Unit |
|---|--------------|--|-------|------|------|------|
|   |              |  | min.  | typ. | max. |      |
| <b>IGBT Characteristic, at <math>T_{vj} = 25^{\circ}\text{C}</math></b> |              |  |       |      |      |      |
| Turn-off delay time   | $t_{d(off)}$ | $T_{vj} = 25^{\circ}\text{C}, V_{CC} = 600\text{V}, I_C = 15.0\text{A}, V_{GE} = 0.0/15.0\text{V}, R_{G(on)} = 14.6\Omega, R_{G(off)} = 14.6\Omega, L_{\sigma} = 180\text{nH}, C_{\sigma} = 39\text{pF}$<br>$L_{\sigma}, C_{\sigma}$ from Fig. E<br>Energy losses include "tail" and diode reverse recovery. | -     | 300  | -    | ns   |
| Fall time   | $t_f$        |  | -     | 46   | -    | ns   |
| Turn-off energy   | $E_{off}$    |  | -     | 0.70 | -    | mJ   |

## Resonant Switching Series

## Switching Characteristic, Inductive Load

| Parameter  | Symbol       | Conditions   | Value |      |      | Unit |
|--|--------------|--|-------|------|------|------|
|  |              |  | min.  | typ. | max. |      |
| <b>IGBT Characteristic, at <math>T_{vj} = 175^{\circ}\text{C}</math></b> |              |  |       |      |      |      |
| Turn-off delay time  | $t_{d(off)}$ | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$V_{CC} = 600\text{V}$ , $I_C = 15.0\text{A}$ ,<br>$V_{GE} = 0.0/15.0\text{V}$ ,<br>$R_{G(on)} = 14.6\Omega$ , $R_{G(off)} = 14.6\Omega$ ,<br>$L_{\sigma} = 180\text{nH}$ , $C_{\sigma} = 39\text{pF}$<br>$L_{\sigma}$ , $C_{\sigma}$ from Fig. E<br>Energy losses include "tail" and<br>diode reverse recovery. | -     | 370  | -    | ns   |
| Fall time  | $t_f$        |  | -     | 90   | -    | ns   |
| Turn-off energy  | $E_{off}$    |  | -     | 1.25 | -    | mJ   |

Resonant Switching Series

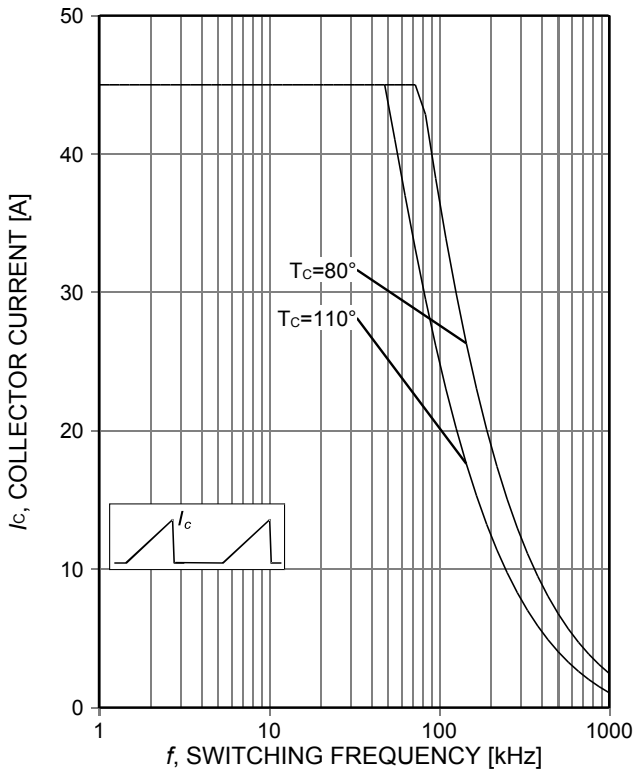


Figure 1. **Collector current as a function of switching frequency**  
 ( $T_j \leq 175^\circ\text{C}$ ,  $D=0.5$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $R_G=14,6\Omega$ )

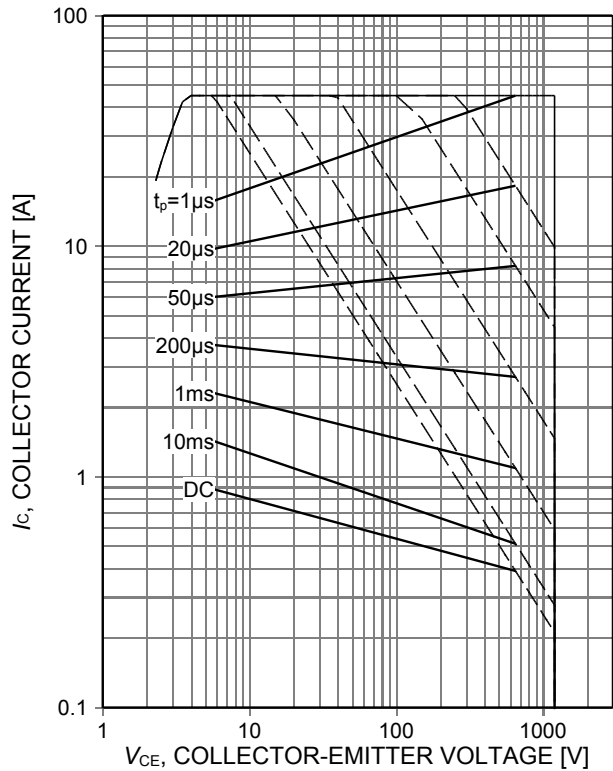


Figure 2. **Forward bias safe operating area**  
 ( $D=0$ ,  $T_C=25^\circ\text{C}$ ,  $T_j \leq 175^\circ\text{C}$ ;  $V_{GE}=15\text{V}$ )

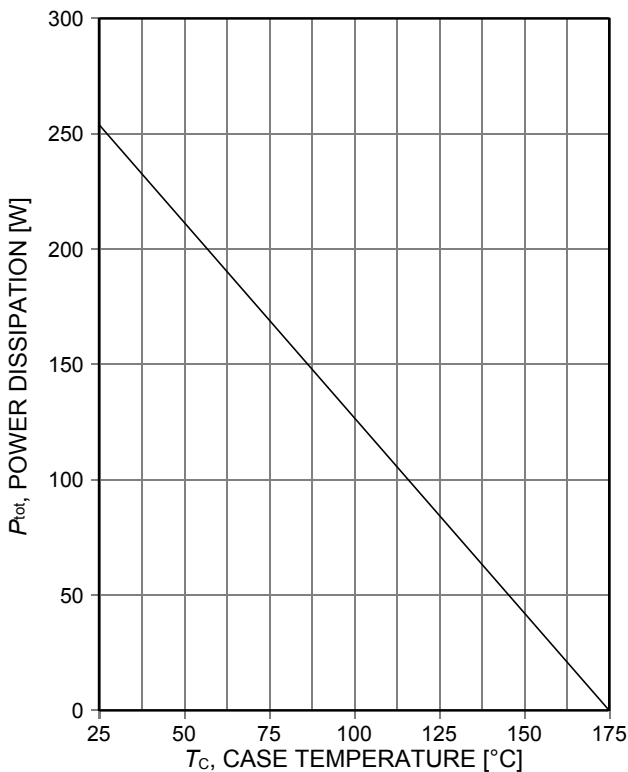


Figure 3. **Power dissipation as a function of case temperature**  
 ( $T_j \leq 175^\circ\text{C}$ )

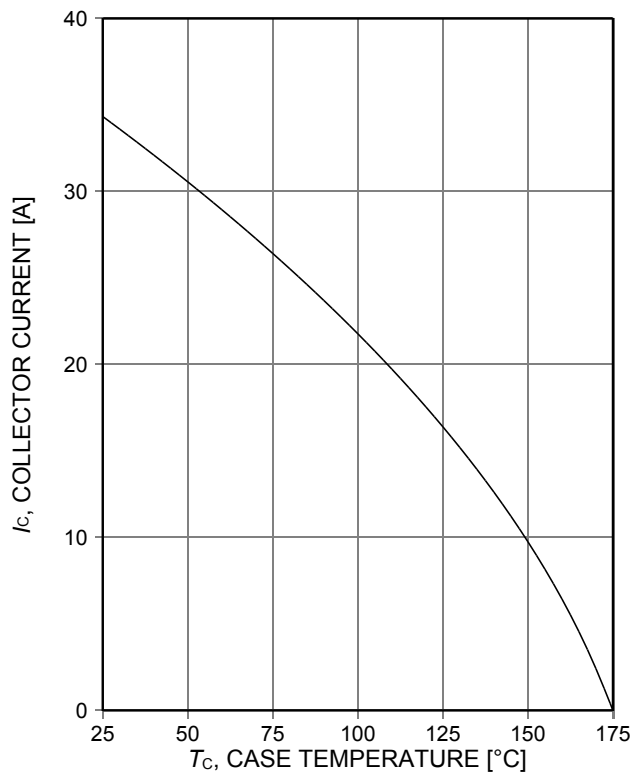


Figure 4. **Collector current as a function of case temperature**  
 ( $V_{GE} \geq 15\text{V}$ ,  $T_j \leq 175^\circ\text{C}$ )

Resonant Switching Series

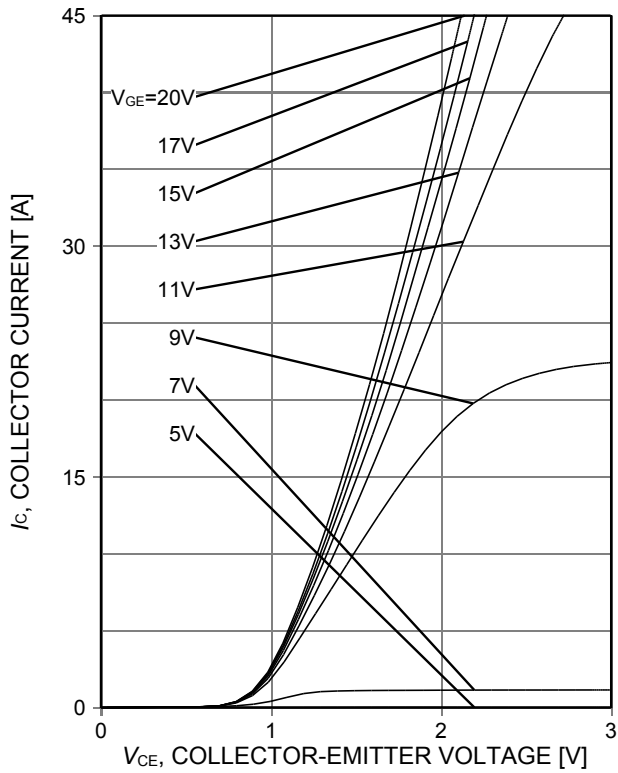


Figure 5. **Typical output characteristic**  
( $T_j=25^{\circ}\text{C}$ )

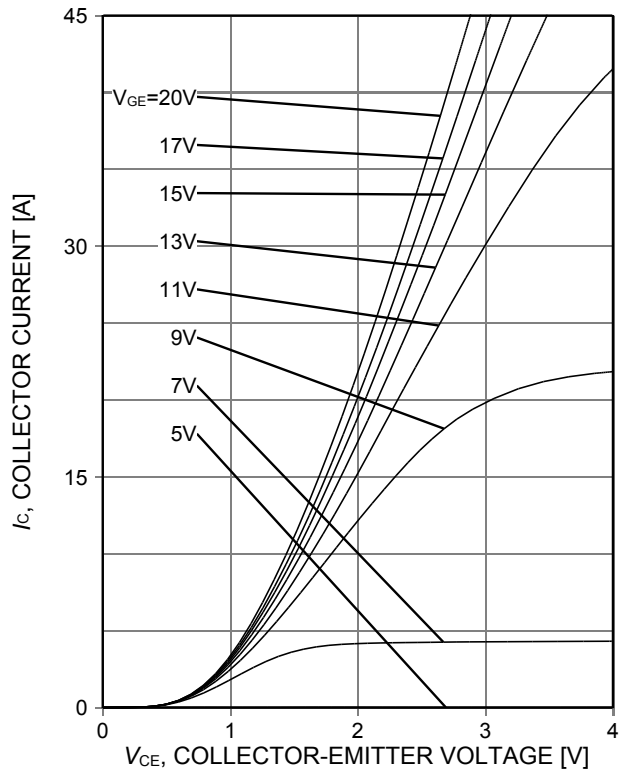


Figure 6. **Typical output characteristic**  
( $T_j=175^{\circ}\text{C}$ )

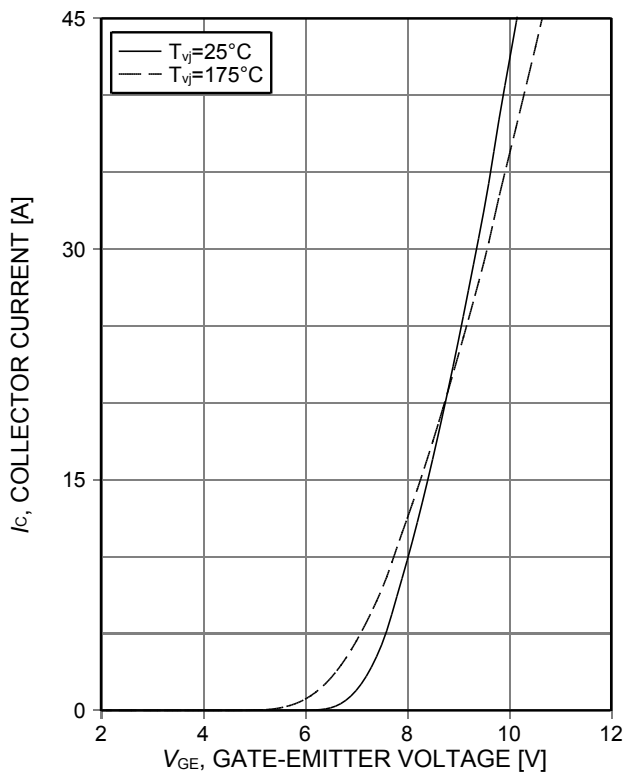


Figure 7. **Typical transfer characteristic**  
( $V_{CE}=20\text{V}$ )

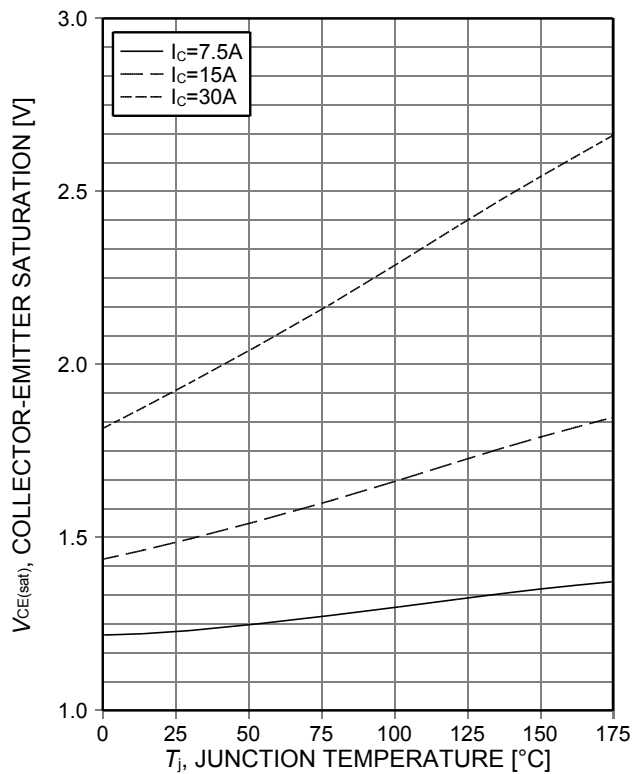


Figure 8. **Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15\text{V}$ )

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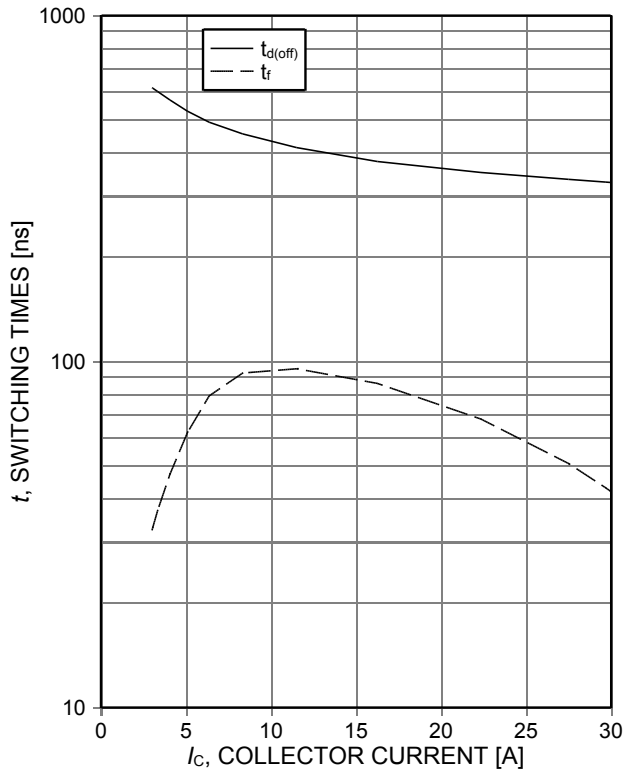


Figure 9. **Typical switching times as a function of collector current**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_{G(on)}=14,6\Omega$ ,  $R_{G(off)}=14,6\Omega$ , test circuit in Fig. E)

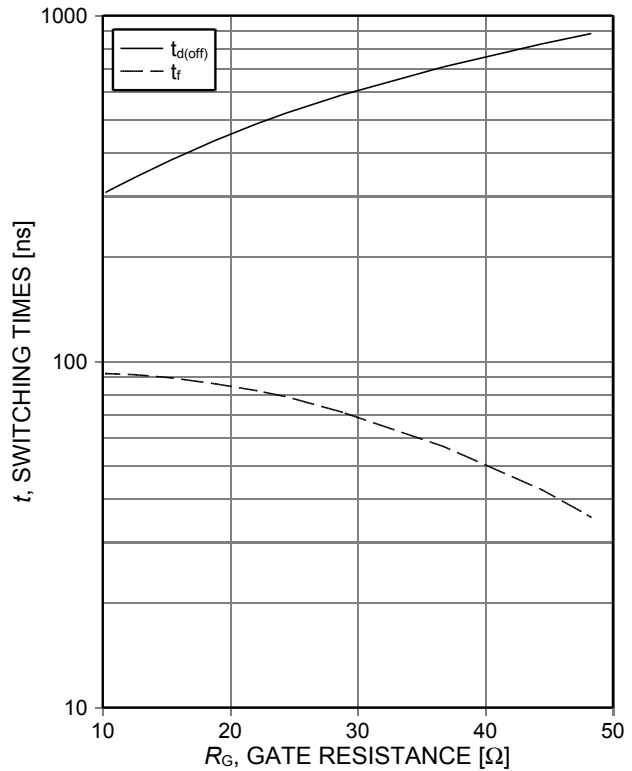


Figure 10. **Typical switching times as a function of gate resistance**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=15\text{A}$ , test circuit in Fig. E)

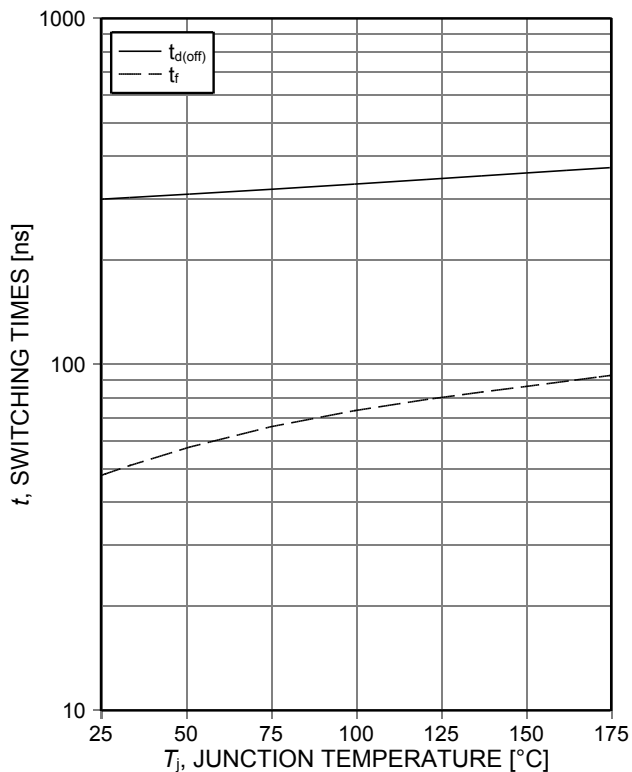


Figure 11. **Typical switching times as a function of junction temperature**  
 (ind. load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=15\text{A}$ ,  $R_{G(on)}=14,6\Omega$ ,  $R_{G(off)}=14,6\Omega$ , test circuit in Fig. E)

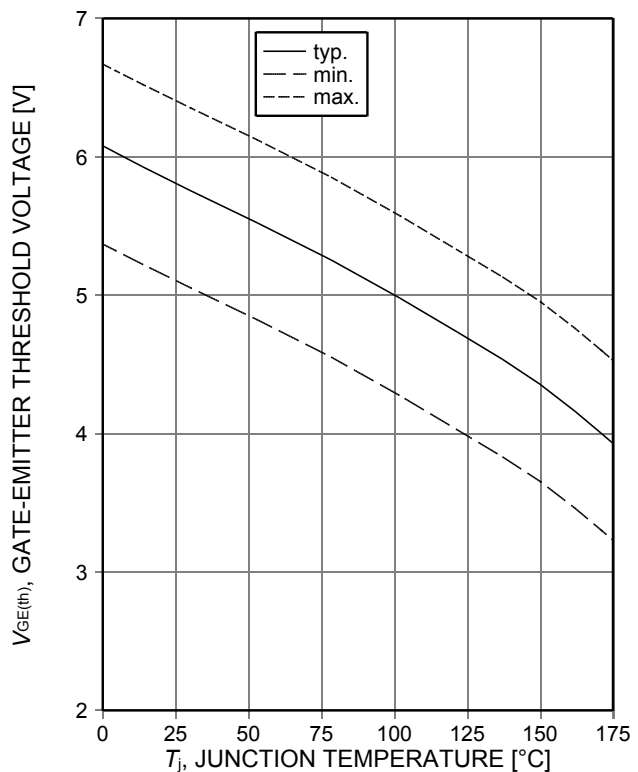


Figure 12. **Gate-emitter threshold voltage as a function of junction temperature**  
 ( $I_C=0.4\text{mA}$ )



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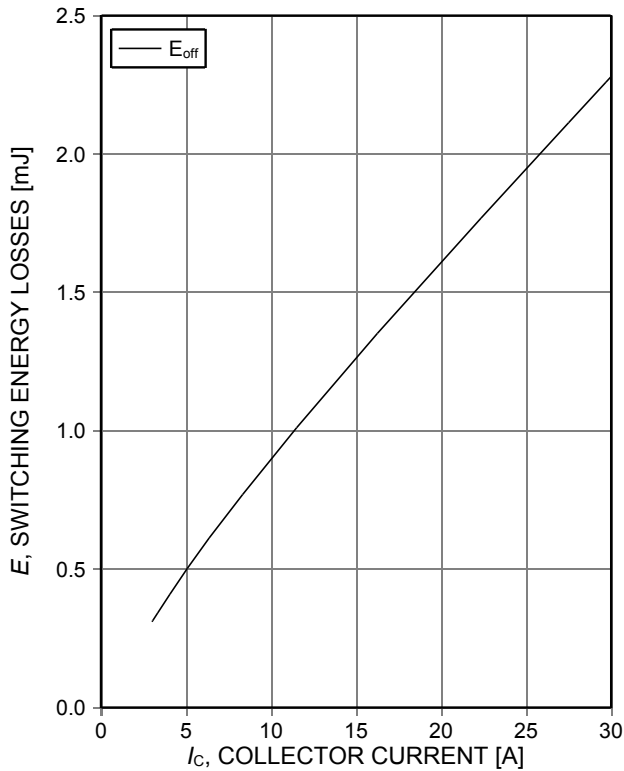


Figure 13. **Typical switching energy losses as a function of collector current**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_{G(on)}=14,6\Omega$ ,  $R_{G(off)}=14,6\Omega$ , test circuit in Fig. E)

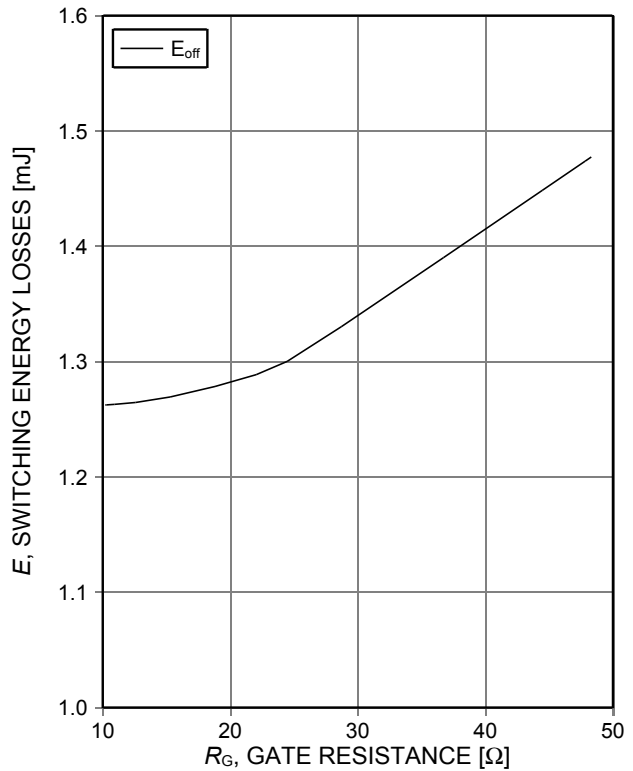


Figure 14. **Typical switching energy losses as a function of gate resistance**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=15\text{A}$ , test circuit in Fig. E)

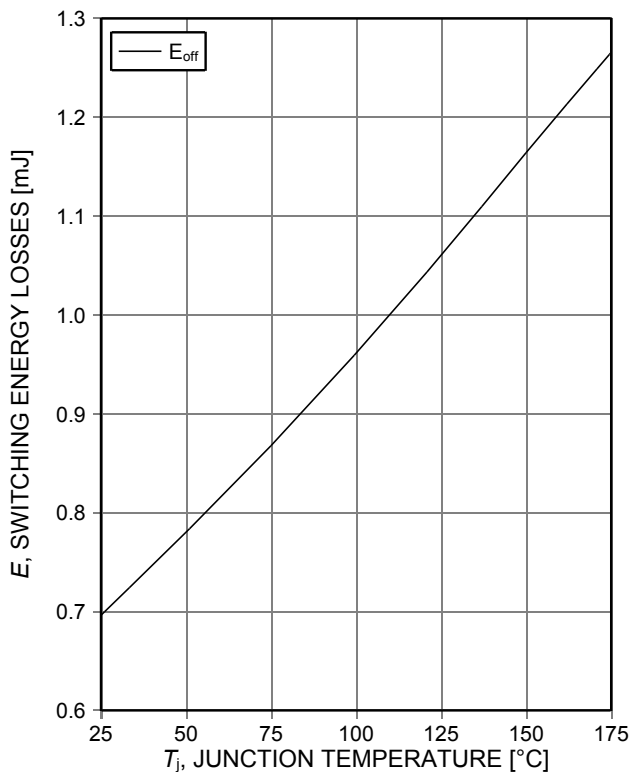


Figure 15. **Typical switching energy losses as a function of junction temperature**  
 (ind load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=15\text{A}$ ,  $R_{G(on)}=14,6\Omega$ ,  $R_{G(off)}=14,6\Omega$ , test circuit in Fig. E)

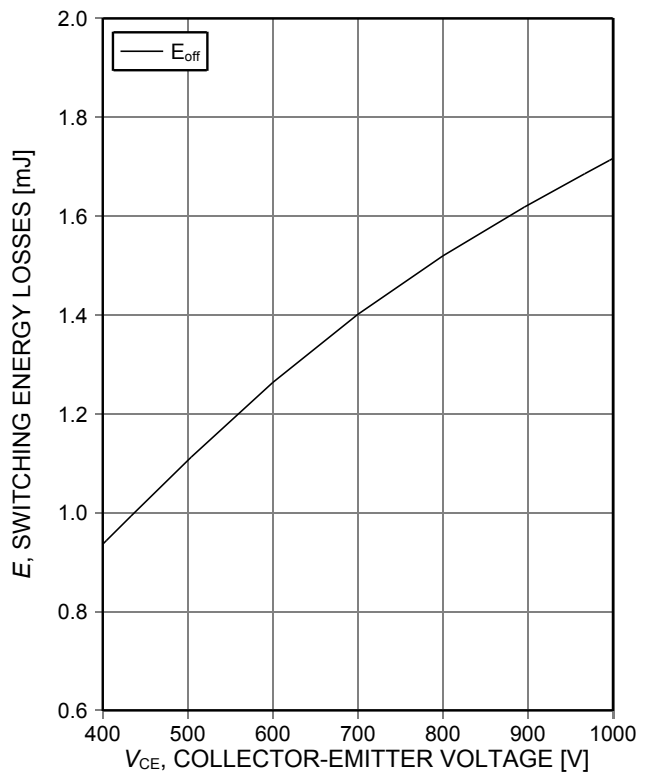


Figure 16. **Typical switching energy losses as a function of collector emitter voltage**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=15\text{A}$ ,  $R_{G(on)}=14,6\Omega$ ,  $R_{G(off)}=14,6\Omega$ , test circuit in Fig. E)

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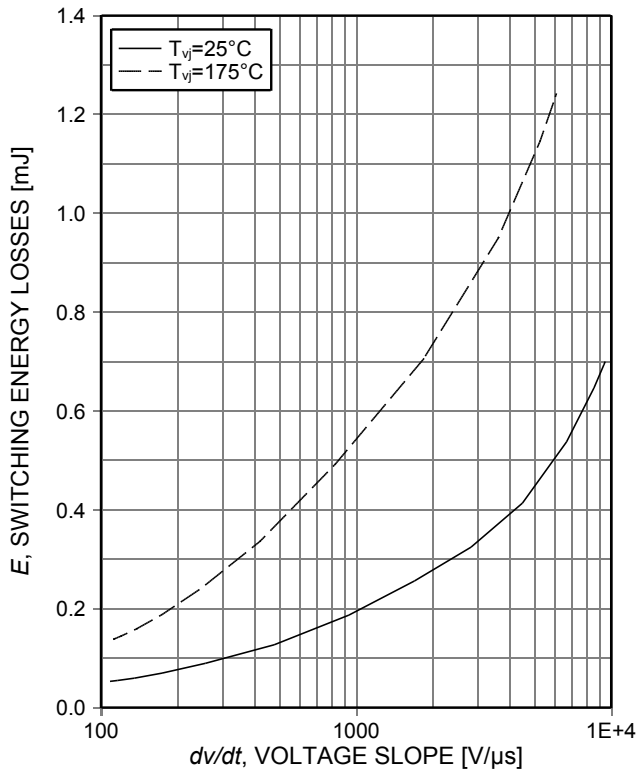


Figure 17. **Typical turn off switching energy loss for soft switching**  
 (ind load,  $V_{CE}=600V$ ,  $V_{GE}=15/0V$ ,  $I_C=15A$ ,  $R_G=14,6\Omega$ , test circuit in Fig. E)

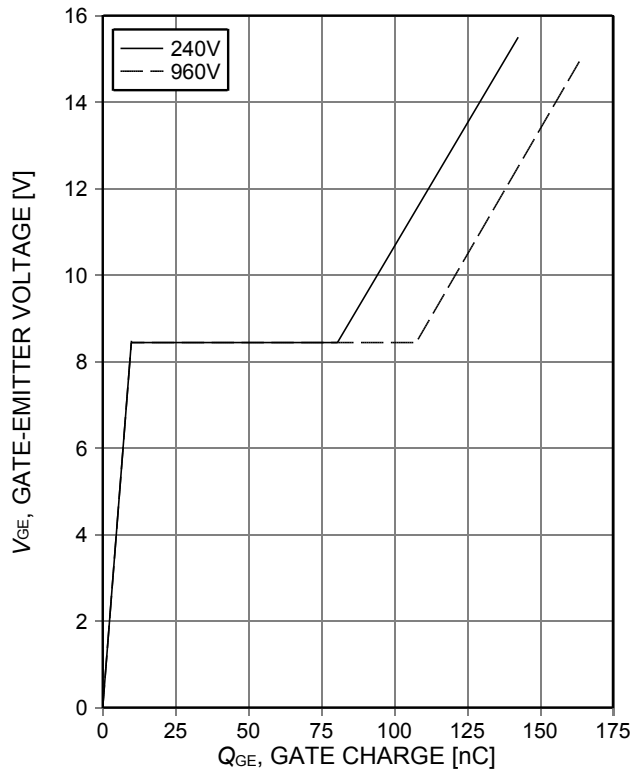


Figure 18. **Typical gate charge**  
 ( $I_C=15A$ )

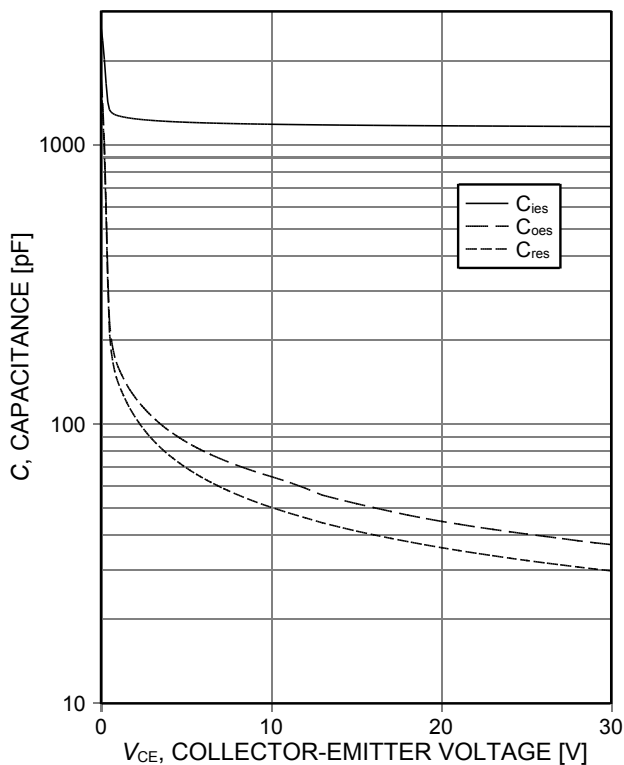


Figure 19. **Typical capacitance as a function of collector-emitter voltage**  
 ( $V_{GE}=0V$ ,  $f=1MHz$ )

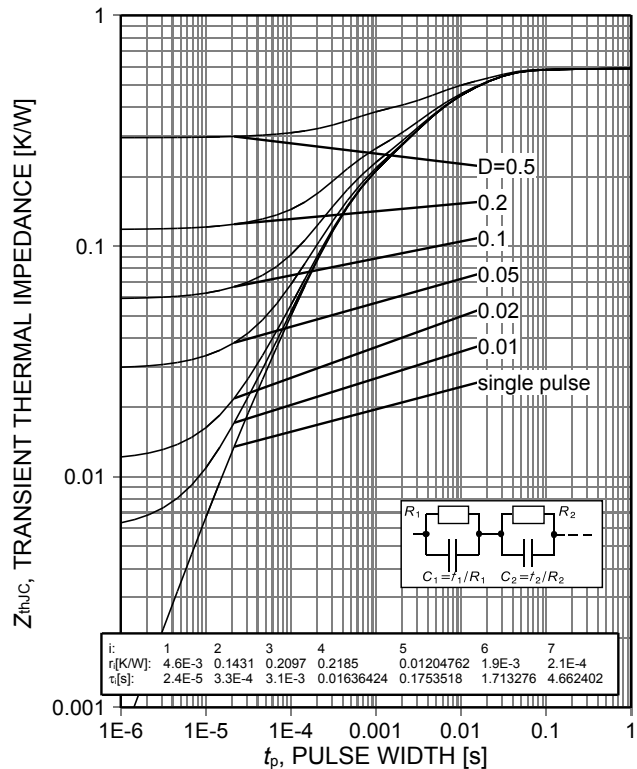


Figure 20. **IGBT transient thermal impedance**  
 ( $D=t_p/T$ )

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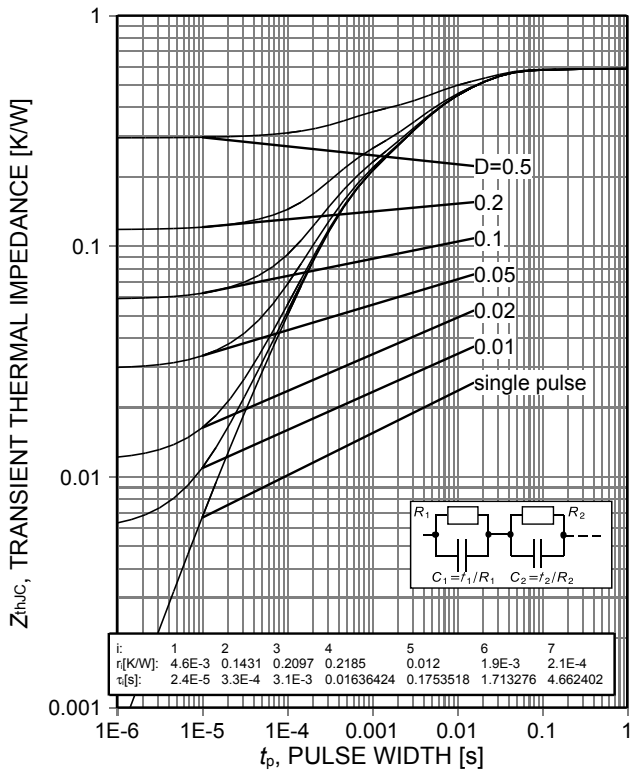


Figure 21. Diode transient thermal impedance as a function of pulse width ( $D=t_p/T$ )

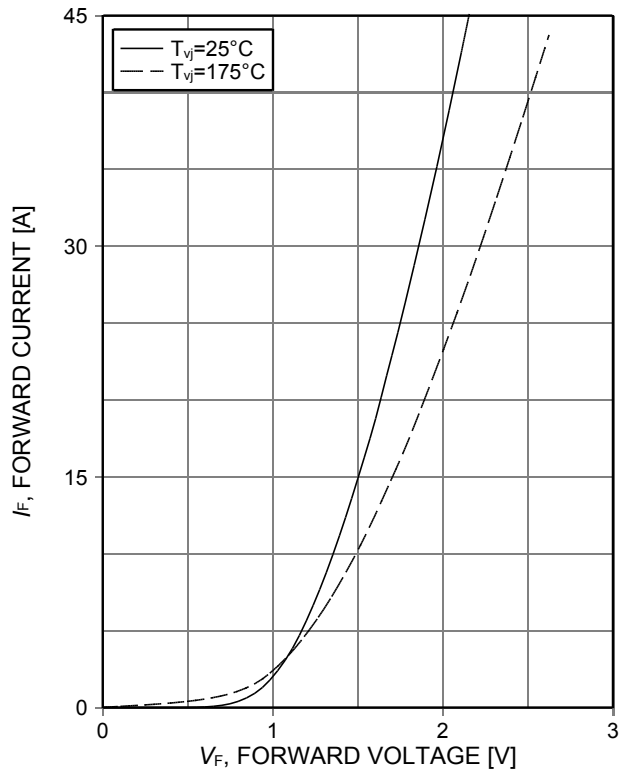


Figure 22. Typical diode forward current as a function of forward voltage

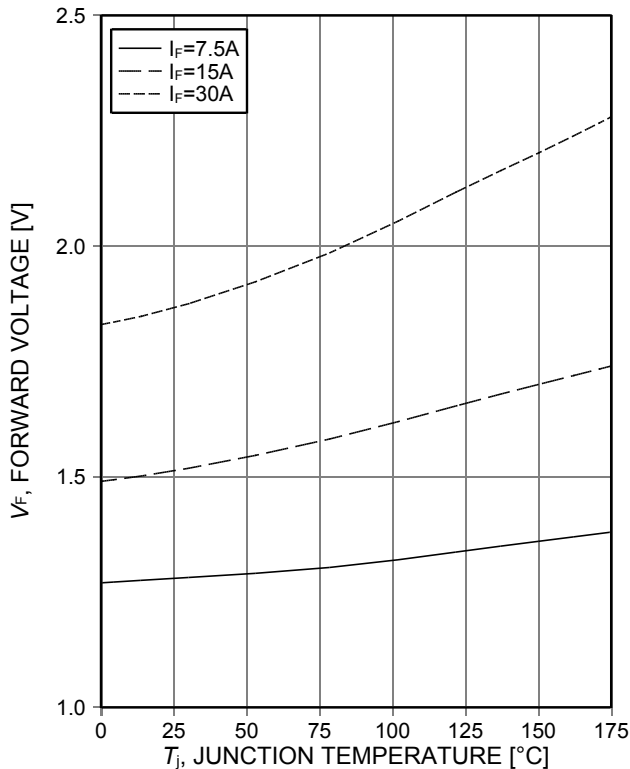
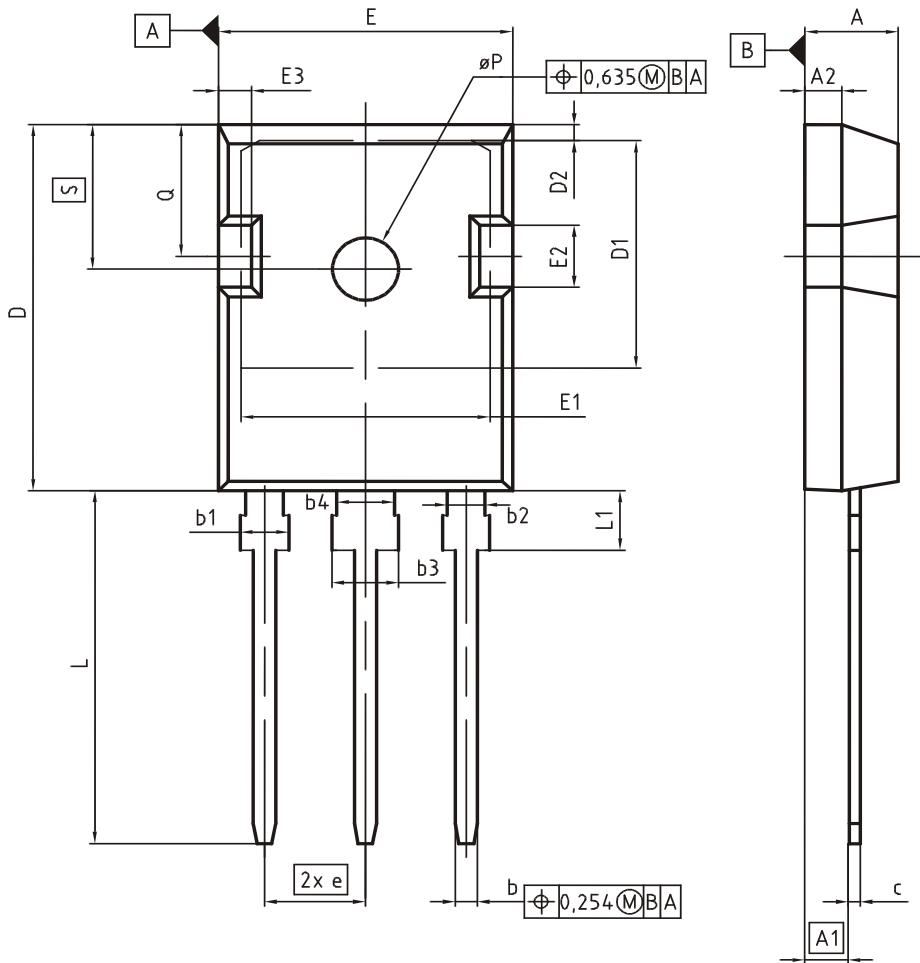


Figure 23. Typical diode forward voltage as a function of junction temperature

### Package Drawing PG-TO247-3



| DIM | MILLIMETERS |       | INCHES      |       |
|-----|-------------|-------|-------------|-------|
|     | MIN         | MAX   | MIN         | MAX   |
| A   | 4.83        | 5.21  | 0.190       | 0.205 |
| A1  | 2.27        | 2.54  | 0.089       | 0.100 |
| A2  | 1.85        | 2.16  | 0.073       | 0.085 |
| b   | 1.07        | 1.33  | 0.042       | 0.052 |
| b1  | 1.90        | 2.41  | 0.075       | 0.095 |
| b2  | 1.90        | 2.16  | 0.075       | 0.085 |
| b3  | 2.87        | 3.38  | 0.113       | 0.133 |
| b4  | 2.87        | 3.13  | 0.113       | 0.123 |
| c   | 0.55        | 0.68  | 0.022       | 0.027 |
| D   | 20.80       | 21.10 | 0.819       | 0.831 |
| D1  | 16.25       | 17.65 | 0.640       | 0.695 |
| D2  | 0.95        | 1.35  | 0.037       | 0.053 |
| E   | 15.70       | 16.13 | 0.618       | 0.635 |
| E1  | 13.10       | 14.15 | 0.516       | 0.557 |
| E2  | 3.68        | 5.10  | 0.145       | 0.201 |
| E3  | 1.00        | 2.60  | 0.039       | 0.102 |
| e   | 5.44 (BSC)  |       | 0.214 (BSC) |       |
| N   | 3           |       | 3           |       |
| L   | 19.80       | 20.32 | 0.780       | 0.800 |
| L1  | 4.10        | 4.47  | 0.161       | 0.176 |
| ØP  | 3.50        | 3.70  | 0.138       | 0.146 |
| Q   | 5.49        | 6.00  | 0.216       | 0.236 |
| S   | 6.04        | 6.30  | 0.238       | 0.248 |

**DOCUMENT NO.**  
Z8B00003327

**SCALE**

**EUROPEAN PROJECTION**

**ISSUE DATE**  
09-07-2010

**REVISION**  
05

Resonant Switching Series

Testing Conditions

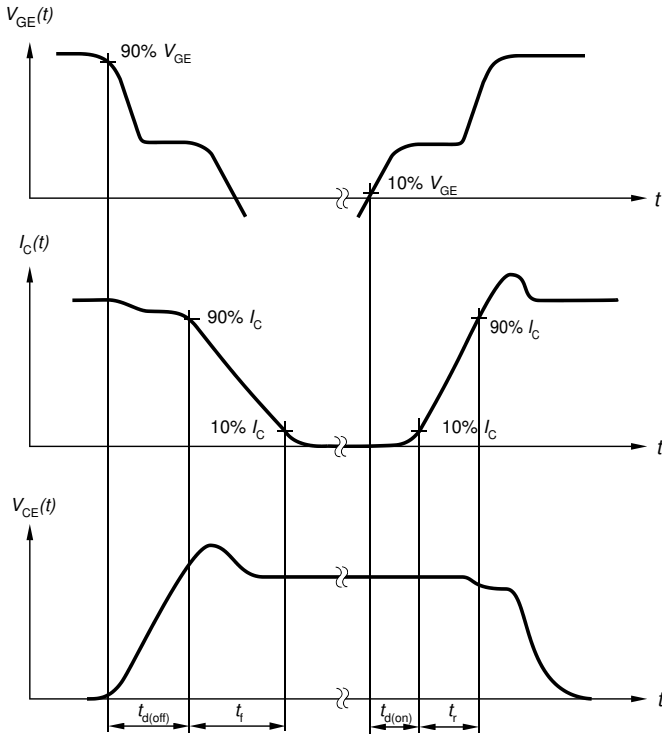


Figure A. Definition of switching times

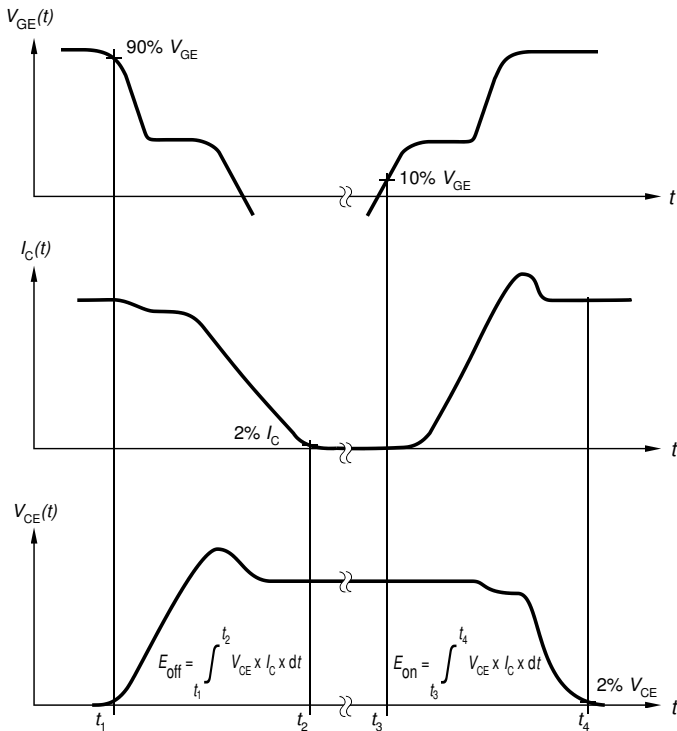


Figure B. Definition of switching losses

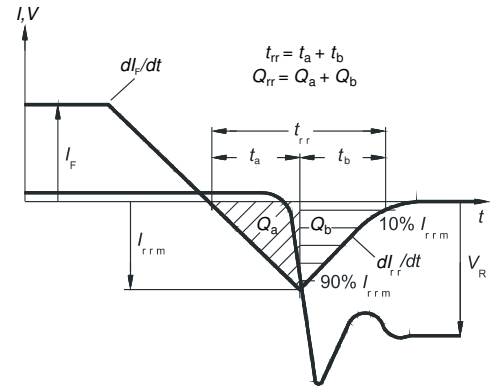


Figure C. Definition of diode switching characteristics

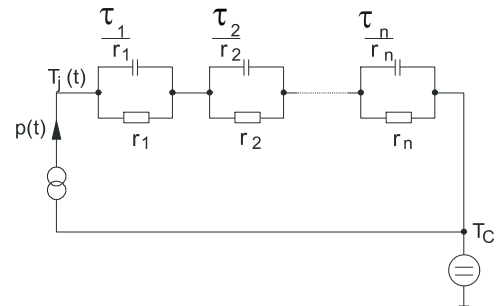


Figure D. Thermal equivalent circuit

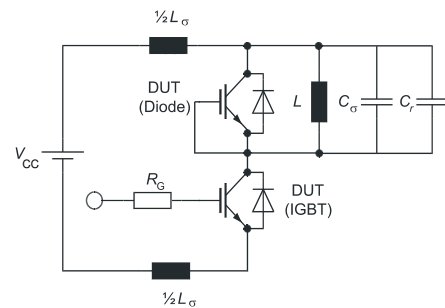


Figure E. Dynamic test circuit  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

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**Resonant Switching Series****Revision History**

IHW15N120R3

**Revision: 2018-03-29, Rev. 2.5**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 1.1      | 2009-04-01 | -  |
| 2.1      | 2009-05-27 | -  |
| 2.2      | 2011-04-05 | Pack. draw. rev. 05, marking update          |
| 2.3      | 2013-02-12 | Layout change                                |
| 2.4      | 2015-01-26 | Minor changes                                |
| 2.5      | 2018-03-29 | Fig.12 and Fig.17 minor change of legend     |

## Trademarks

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**Published by  
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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
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- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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